

L Number	Hits	Search Text	DB	Time stamp
1	1	("6461937").PN.	USPAT	2003/03/11 12:10
2	1	("4571819").PN.	USPAT	2003/03/11 13:10
3	1	("20020027265").PN.	USPAT; US-PGPUB	2003/03/11 13:11
4	1	("5856911").PN.	USPAT;	2003/03/11 13:30
5	1	("5721286").PN.	USPAT; US-PGPUB	2003/03/11 13:43
6	255	((microwave or frequency) with (epoxy and cur\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 13:57
7	205	((((microwave or frequency) with (epoxy and cur\$3))) and (@ad<19991230)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 13:59
8	41	((((microwave or frequency) with (epoxy and cur\$3))) and (@ad<19991230)) and (chip or die or ic)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 13:51
9	172	((microwave or frequency) with (epoxy and (cure or curing or cured)))	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 13:50
10	133	((((microwave or frequency) with (epoxy and (cure or curing or cured)))) and (@ad<19991230)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 13:51
11	28	((((microwave or frequency) with (epoxy and (cure or curing or cured)))) and (@ad<19991230)) and (chip or die or ic)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 13:51
12	86	(microwave near (curing or cured or cure)) and (chip or die or ic)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 13:58
13	12	((microwave near (curing or cured or cure)) and (chip or die or ic)) and ((heat or thermal) adj (sink or spreader or dissipation or dissipate))	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 13:59
14	11	((((microwave near (curing or cured or cure)) and (chip or die or ic)) and ((heat or thermal) adj (sink or spreader or dissipation or dissipate))) and (@ad<19991230)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 14:14
15	6	((((microwave near (curing or cured or cure)) and (chip or die or ic)) and ((heat or thermal) adj (sink or spreader or dissipation or dissipate))) and (@ad<19991230)) and epoxy	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 14:08
16	1	("6191360").PN.	IBM_TDB	
17	890	257/778.cccls. and heat	USPAT USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 14:13 2003/03/11 14:13
18	193	(257/778.cccls. and heat) and (ball and (sink or spreader))	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/11 14:14

19	135	((257/778.ccls. and heat) and (ball and (sink or spreader))) and (@ad<19991230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/03/11 14:17
20	0	257/707.ccls. and (microwave near (cure or curing or cured))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/03/11 14:16
21	609	257/707.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/03/11 14:16
22	0	257/707.ccls. and (microwave near (cure or curing or cured))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/03/11 14:16
23	174	257/707.ccls. and ball	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/03/11 14:16
24	125	(257/707.ccls. and ball) and (@ad<19991230)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/03/11 14:23
25	922	257/706.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/03/11 14:24